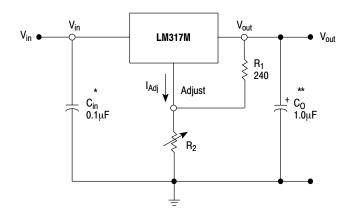
500 mA Adjustable Output, Positive Voltage Regulator

The LM317M is an adjustable three-terminal positive voltage regulator capable of supplying in excess of 500 mA over an output voltage range of 1.2 V to 37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow-out proof.

The LM317M serves a wide variety of applications including local, on—card regulation. This device also makes an especially simple adjustable switching regulator, a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM317M can be used as a precision current regulator.

Features

- Output Current in Excess of 500 mA
- Output Adjustable between 1.2 V and 37 V
- Internal Thermal Overload Protection
- Internal Short Circuit Current Limiting
- Output Transistor Safe-Area Compensation
- Floating Operation for High Voltage Applications
- Eliminates Stocking Many Fixed Voltages
- Pb-Free Packages are Available



 * = C_{in} is required if regulator is located an appreciable distance from power supply filter. ** = C_{Ω} is not needed for stability, however, it does improve transient response.

$$V_{out} \, = \, 1.25 \ V \left(1 \, + \, \frac{R_2}{R_1} \right) \, + \, I_{Adj} \, R_2$$

Since I_{Adj} is controlled to less than 100 μ A, the error associated with this term is negligible in most applications.

Figure 1. Simplified Application



ON Semiconductor®

http://onsemi.com

Heatsink surface connected to Pin 2

TO-220AB T SUFFIX CASE 221A



SOT-223 ST SUFFIX CASE 318E



DPAK DT SUFFIX CASE 369C



Heatsink Surface (shown as terminal 4 in case outline drawing) is connected to Pin 2.

PIN ASSIGNMENT			
1	Adjust		
2	V _{out}		
3	V _{in}		

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 13 of this data sheet.

MAXIMUM RATINGS ($T_A = 25^{\circ}C$, unless otherwise noted.)

Rating	Symbol	Value	Unit
Input-Output Voltage Differential	V_I – V_O	40	Vdc
Power Dissipation (Package Limitation) (Note 1)			
Plastic Package, T Suffix, Case 221A			
$T_A = 25^{\circ}C$	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	θ_{JA}	70	°C/W
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	5.0	°C/W
Plastic Package, DT Suffix, Case 369C			
$T_A = 25$ °C	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	θ_{JA}	92	°C/W
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	5.0	°C/W
Plastic Package, ST Suffix, Case 318E			
$T_A = 25$ °C	P_{D}	Internally Limited	
Thermal Resistance, Junction-to-Air	θ_{JA}	245	°C/W
Thermal Resistance, Junction-to-Case	$\theta_{\sf JC}$	15	°C/W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Figure 25 provides thermal resistance versus pc board pad size.

ELECTRICAL CHARACTERISTICS ($V_I - V_O = 5.0 \text{ V}$; $I_O = 0.1 \text{ A}$, $T_J = T_{low}$ to T_{high} (Note 2), unless otherwise noted.)

			LM317M / LM317MB			
Characteristics	Figure	Symbol	Min	Тур	Max	Unit
Line Regulation (Note 3) ($T_A = 25^{\circ}C$, $3.0 \text{ V} \le V_I - V_O \le 40 \text{ V}$)	3	Reg _{line}	-	0.01	0.04	%/V
Load Regulation (Note 3) $T_A = 25^{\circ}C, 10 \text{ mA} \le I_O \le 0.5 \text{ A}$ $V_O \le 5.0 \text{ V}$ $V_O \ge 5.0 \text{ V}$	4	Reg _{load}	- -	5.0 0.1	25 0.5	mV % V _O
Adjustment Pin Current	5	I_{Adj}	-	50	100	μΑ
Adjustment Pin Current Change $2.5 \text{ V} \leq \text{V}_I - \text{V}_O \leq 40 \text{ V}, \ 10 \text{ mA} \leq \text{I}_L \leq 0.5 \text{ A}, \ P_D \leq P_{max}$	3, 4	ΔI_{Adj}	_	0.2	5.0	μΑ
Reference Voltage 3.0 V \leq V _I - V _O \leq 40 V, 10 mA \leq I _L \leq 0.5 A, P _D \leq P _{max}	5	V _{ref}	1.200	1.250	1.300	V
Line Regulation (Note 3) 3.0 $V \le V_1 - V_0 \le 40 \text{ V}$	3	Reg _{line}	_	0.02	0.07	%/V
Load Regulation (Note 3) $10 \text{ mA} \le I_O \le 0.5 \text{ A}$ $V_O \le 5.0 \text{ V}$ $V_O \ge 5.0 \text{ V}$	4	Reg _{load}	- -	20 0.3	70 1.5	mV % V _O
Temperature Stability $(T_{low} \le T_J \le T_{high})$	5	T _S	-	0.7	_	% V _O
Minimum Load Current to Maintain Regulation $(V_I - V_O = 40 \text{ V})$	5	I _{Lmin}	-	3.5	10	mA
Maximum Output Current $V_I - V_O \le 15 \text{ V}, P_D \le P_{max}$ $V_I - V_O = 40 \text{ V}, P_D \le P_{max}, T_A = 25^{\circ}\text{C}$	5	I _{max}	0.5 0.15	0.9 0.25	_ _	Α
RMS Noise, % of V_O ($T_A = 25^{\circ}C$, 10 Hz \leq f \leq 10 kHz)	-	N	-	0.003	_	% V _O
Ripple Rejection, V_O = 10 V, f = 120 Hz (Note 4) Without C_{Adj} C_{Adj} = 10 μ F	6	RR	_ 66	65 80	_ _	dB
Long-Term Stability, $T_J = T_{high}$ (Note 5) $T_A = 25^{\circ}C$ for End-point Measurements	5	S	_	0.3	1.0	%/1.0 kHrs.

T_{low} to T_{high} = 0° to +125°C for LM317M T_{low} to T_{high} = -40° to +125°C for LM317MB.
 Load and line regulation are specified at constant junction temperature. Changes in V_O due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
 C_{Adj}, when used, is connected between the adjustment pin and ground.
 Since Long-Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot to let

stability from lot-to-lot.

ELECTRICAL CHARACTERISTICS ($V_I - V_O = 5.0 \text{ V}$; $I_O = 0.1 \text{ A}$, $T_J = T_{low}$ to T_{high} (Note 6), unless otherwise noted.)

			LM317MA / LM317MAB			
Characteristics	Figure	Symbol	Min	Тур	Max	Unit
Line Regulation (Note 7) ($T_A = 25^{\circ}C$, 3.0 V \leq V _I $-$ V _O \leq 40 V)	3	Reg _{line}	-	0.01	0.04	%/V
Load Regulation (Note 7) $T_A = 25^{\circ}\text{C}, \ 10 \ \text{mA} \le I_O \le 0.5 \ \text{A}$ $V_O \le 5.0 \ \text{V}$ $V_O \ge 5.0 \ \text{V}$	4	Reg _{load}	- -	5.0 0.1	25 0.5	mV % V _O
Adjustment Pin Current	5	I_{Adj}	-	50	100	μΑ
Adjustment Pin Current Change $2.5~\text{V} \leq \text{V}_{\text{I}} - \text{V}_{\text{O}} \leq 40~\text{V},~10~\text{mA} \leq \text{I}_{\text{L}} \leq 0.5~\text{A},~\text{P}_{\text{D}} \leq \text{P}_{\text{max}}$	3, 4	ΔI_{Adj}	_	0.2	5.0	μΑ
Reference Voltage 3.0 V \leq V _I $-$ V _O \leq 40 V, 10 mA \leq I _L \leq 0.5 A, P _D \leq P _{max}	5	V _{ref}	1.225	1.250	1.275	V
Line Regulation (Note 7) 3.0 $V \le V_I - V_O \le 40 \text{ V}$	3	Reg _{line}	_	0.02	0.07	%/V
Load Regulation (Note 7) 10 mA \leq I _O \leq 0.5 A V _O \leq 5.0 V V _O \geq 5.0 V	4	Reg _{load}	- -	20 0.3	70 1.5	mV % V _O
Temperature Stability $(T_{low} \le T_J \le T_{high})$	5	T _S	_	0.7	_	% V _O
Minimum Load Current to Maintain Regulation $(V_I - V_O = 40 \text{ V})$	5	I _{Lmin}	-	3.5	10	mA
Maximum Output Current $V_I - V_O \le 15 \text{ V}, P_D \le P_{max}$ $V_I - V_O = 40 \text{ V}, P_D \le P_{max}, T_A = 25^{\circ}\text{C}$	5	I _{max}	0.5 0.15	0.9 0.25	_ _	А
RMS Noise, % of V_O ($T_A = 25^{\circ}C$, 10 Hz \leq f \leq 10 kHz)	-	N	-	_	_	% V _O
Ripple Rejection, V_O = 10 V, f = 120 Hz (Note 8) Without C_{Adj} C_{Adj} = 10 μ F	6	RR	_ 66	65 80	_ _	dB
Long–Term Stability, $T_J = T_{high}$ (Note 9) $T_A = 25^{\circ}C$ for End–point Measurements	5	S	_	0.3	1.0	%/1.0 kHrs.

T_{low} to T_{high} = 0° to +125°C for LM317MA T_{low} to T_{high} = -40° to +125°C for LM317MAB.
 Load and line regulation are specified at constant junction temperature. Changes in V_O due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
 C_{Adj}, when used, is connected between the adjustment pin and ground.
 Since Long-Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average

stability from lot-to-lot.

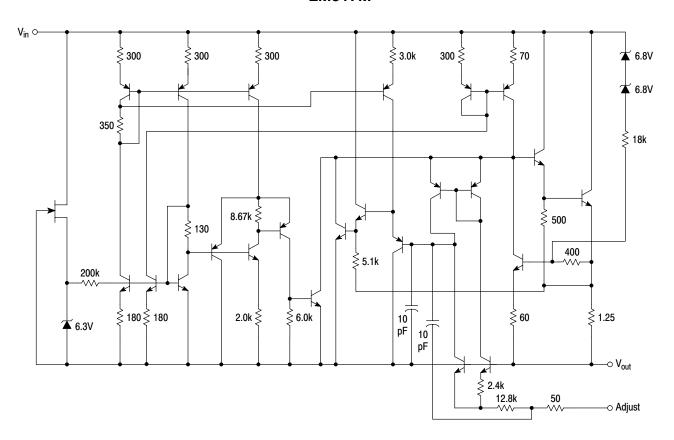


Figure 2. Representative Schematic Diagram

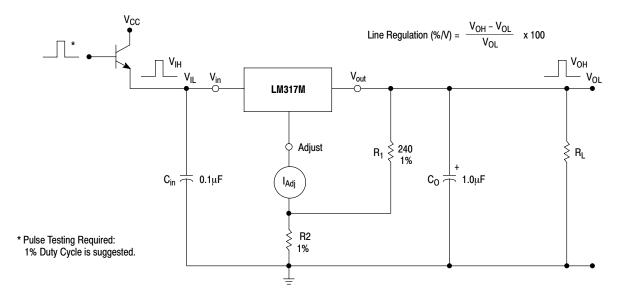


Figure 3. Line Regulation and $\Delta I_{\mbox{\sc Adj}}\mbox{/Line}$ Test Circuit

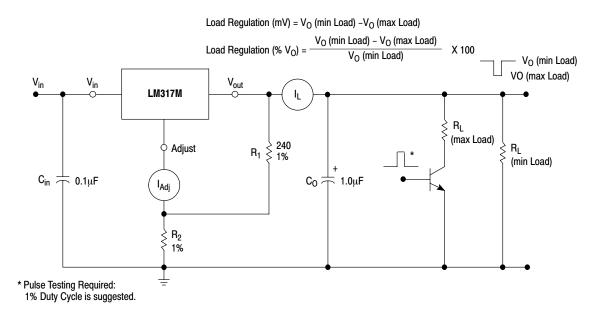


Figure 4. Load Regulation and $\Delta I_{\mbox{\scriptsize Adj}}/\mbox{\scriptsize Load}$ Test Circuit

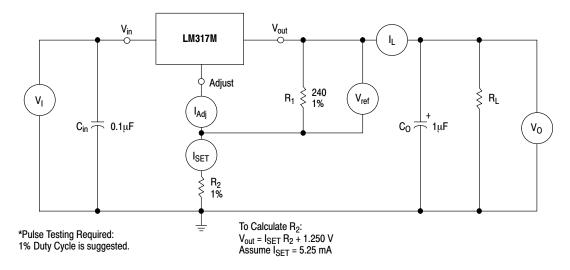


Figure 5. Standard Test Circuit

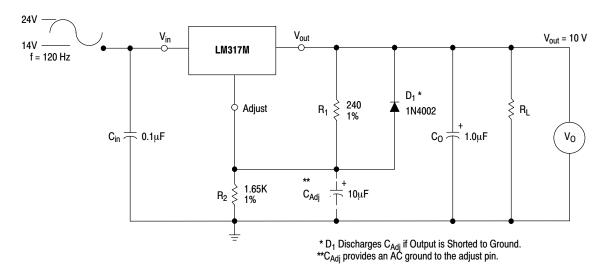


Figure 6. Ripple Rejection Test Circuit

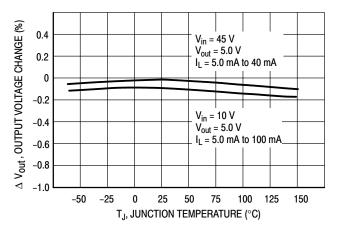


Figure 7. Load Regulation

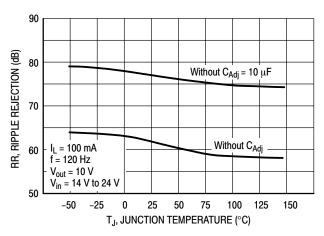


Figure 8. Ripple Rejection

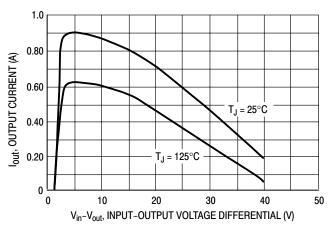


Figure 9. Current Limit

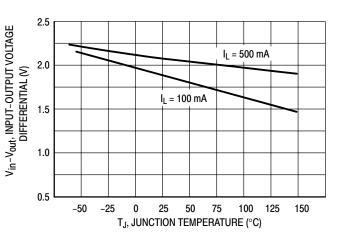


Figure 10. Dropout Voltage

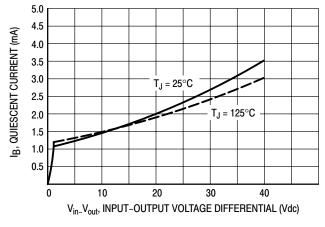


Figure 11. Minimum Operating Current

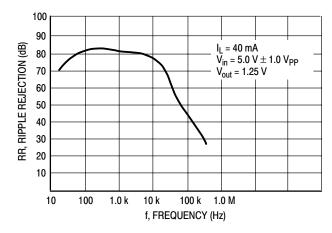


Figure 12. Ripple Rejection versus Frequency

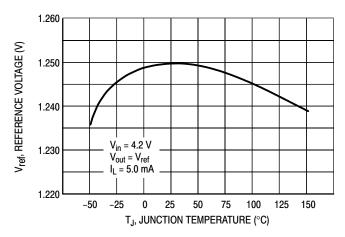


Figure 13. Temperature Stability

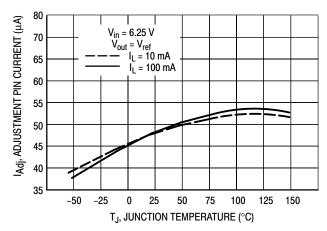


Figure 14. Adjustment Pin Current

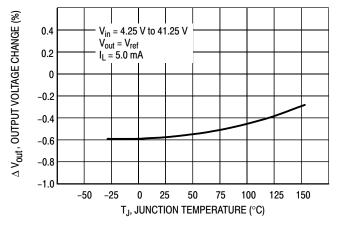


Figure 15. Line Regulation

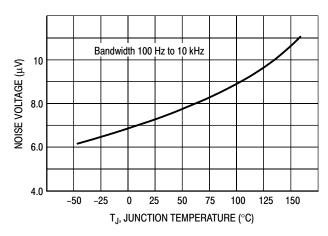


Figure 16. Output Noise

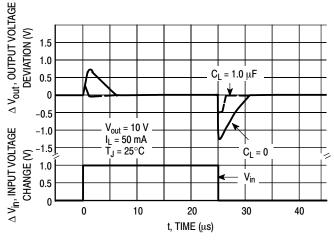


Figure 17. Line Transient Response

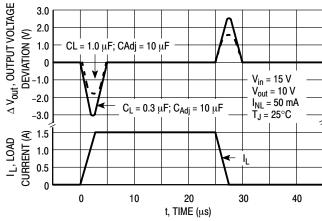


Figure 18. Load Transient Response

APPLICATIONS INFORMATION

Basic Circuit Operation

The LM317M is a three–terminal floating regulator. In operation, the LM317M develops and maintains a nominal 1.25 V reference (V_{ref}) between its output and adjustment terminals. This reference voltage is converted to a programming current (I_{PROG}) by R_1 (see Figure 19), and this constant current flows through R_2 to ground. The regulated output voltage is given by:

$$V_{out} = V_{ref} \left(1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since the current from the terminal (I_{Adj}) represents an error term in the equation, the LM317M was designed to control I_{Adj} to less than 100 μA and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM317M is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

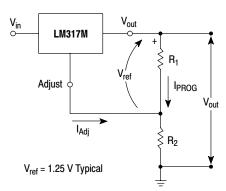


Figure 19. Basic Circuit Configuration

Load Regulation

The LM317M is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor (R_1) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of R_2 can be returned near the load ground to provide remote ground sensing and improve load regulation.

External Capacitors

A $0.1\,\mu F$ disc or $1.0\,\mu F$ tantalum input bypass capacitor (C_{in}) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor (C_{Adj}) prevents ripple from being amplified as the output voltage is increased. A 10 μF capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10 V application.

Although the LM317M is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance (C_O) in the form of a 1.0 μF tantalum or 25 μF aluminum electrolytic capacitor on the output swamps this effect and insures stability.

Protection Diodes

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 20 shows the LM317M with the recommended protection diodes for output voltages in excess of 25 V or high capacitance values ($C_O > 25 \, \mu F$, $C_{Adj} > 5.0 \, \mu F$). Diode D_1 prevents C_O from discharging thru the IC during an input short circuit. Diode D_2 protects against capacitor C_{Adj} discharging through the IC during an output short circuit. The combination of diodes D_1 and D_2 prevents C_{Adj} from discharging through the IC during an input short circuit.

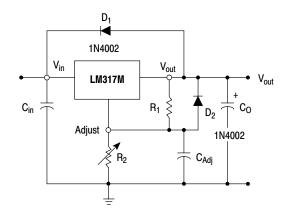


Figure 20. Voltage Regulator with Protection Diodes

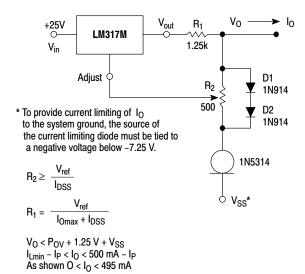


Figure 21. Adjustable Current Limiter

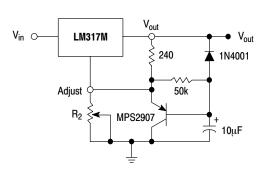
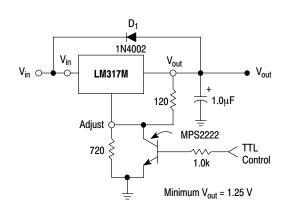


Figure 23. Slow Turn-On Regulator



D₁ protects the device during an input short circuit.

Figure 22. 5 V Electronic Shutdown Regulator

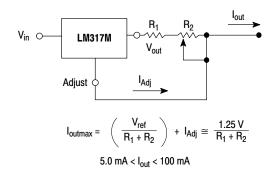


Figure 24. Current Regulator

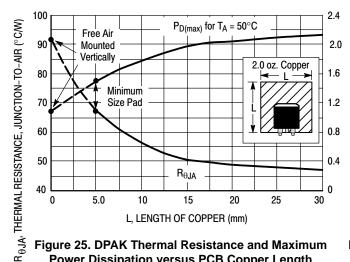


Figure 25. DPAK Thermal Resistance and Maximum **Power Dissipation versus PCB Copper Length**

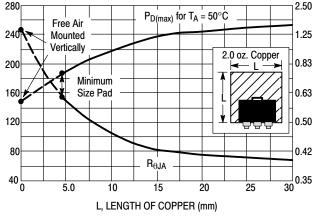


Figure 26. SOT-223 Thermal Resistance and Maximum **Power Dissipation versus PCB Copper Length**

ORDERING INFORMATION

Device	Output Voltage Tolerance	Operating Temperature Range	Package	Shipping [†]
LM317MABDT			DPAK	75 Units/Rail
LM317MABDTRK		$T_J = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$	DPAK	2500/Tape & Reel
LM317MABT	- 2%		TO-220	50 Units/Rail
LM317MADTRK		$T_J = 0$ °C to 125°C	DPAK	2500/Tape & Reel
LM317MBDT			DPAK	75 Units/Rail
LM317MBDTRK			DPAK	2500/Tape & Reel
LM317MBDTRKG		T _J = -40°C to 125°C	DPAK (Pb-Free)	2500/Tape & Reel
LM317MBSTT3			SOT-223	4000/Tape & Reel
LM317MBT			TO-220	50 Units/Rail
LM317MDT		T _J = 0°C to 125°C	DPAK	75 Units/Rail
LM317MDTG	4%		DPAK (Pb-Free)	75 Units/Rail
LM317MDTRK			DPAK	2500/Tape & Reel
LM317MDTRKG			DPAK (Pb-Free)	2500/Tape & Reel
LM317MSTT3			SOT-223	4000/Tape & Reel
LM317MT			TO-220	50 Units/Rail
LM317MTG			TO-220 (Pb-Free)	50 Units/Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MARKING DIAGRAMS

DPAK DT SUFFIX CASE 369C

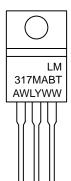


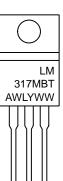


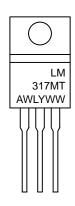


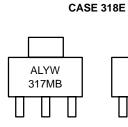


TO-220 T SUFFIX CASE 221A









SOT-223

ST SUFFIX

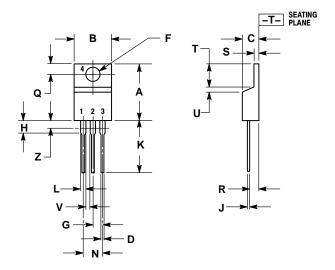


A = Assembly Location

WL, L = Wafer Lot Y = Year WW, W = Work Week

PACKAGE DIMENSIONS

TO-220 T SUFFIX PLASTIC PACKAGE CASE 221A-09 **ISSUE AA**

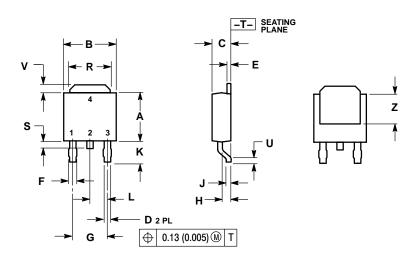


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

PACKAGE DIMENSIONS

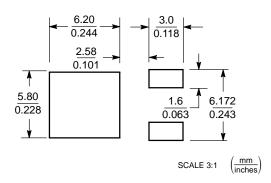
DPAK DT SUFFIX PLASTIC PACKAGE CASE 369C-01 **ISSUE O**



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.22
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
Е	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180	BSC	4.58 BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090	0.090 BSC		BSC
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020		0.51	
٧	0.035	0.050	0.89	1.27
Z	0.155		3.93	

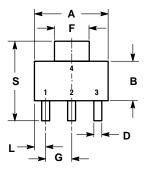
SOLDERING FOOTPRINT*

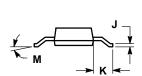


^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

SOT-223 ST SUFFIX PLASTIC PACKAGE CASE 318E-04 ISSUE K

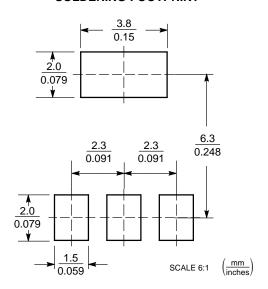




- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.249	0.263	6.30	6.70
В	0.130	0.145	3.30	3.70
С	0.060	0.068	1.50	1.75
D	0.024	0.035	0.60	0.89
F	0.115	0.126	2.90	3.20
G	0.087	0.094	2.20	2.40
Н	0.0008	0.0040	0.020	0.100
J	0.009	0.014	0.24	0.35
K	0.060	0.078	1.50	2.00
L	0.033	0.041	0.85	1.05
M	0 °	10 °	0 °	10 °
S	0.264	0.287	6.70	7.30

SOLDERING FOOTPRINT



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